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	Application Number		10826887		
	Filing Date		2004-04-16		
INFORMATION DISCLOSURE	First Named Inventor Chak		nakraborty, et al.		
STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Art Unit		1791		
(NOTION Submission under 37 GFK 1.33)	Examiner Name	Wolls	chlager		
	Attorney Docket Numb	er	133737-1		

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	1	New	High Pressure Moulding Technique, RESIN NEWS, Vol. 15, Issue 11, published 1976-01-31, 1 page					
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